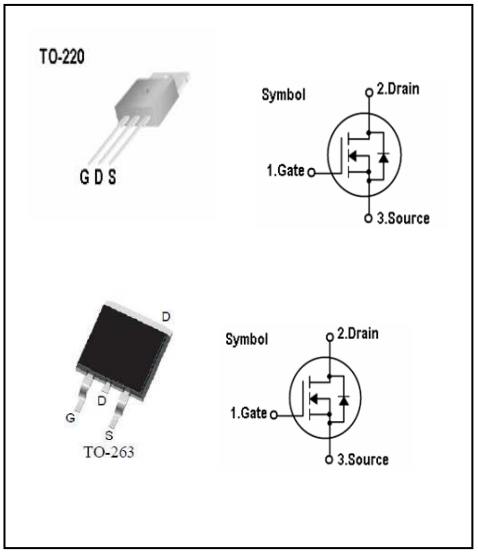
S80N08R/S/RN/RP

N-Channel MOSFET



Features

- 80V,80A,Rds(on)(typ)=6.4mΩ@Vgs=10V
- High Ruggedness
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability

General Description

This Power MOSFET is produced using Si-Tech's advanced Trench MOS Technology. This latest technology has been especially designed to minimize on-state resistance, have a high rugged avalanche characteristics.These devices are well suited for low voltage application such as automotive,DC/DC converters,and high efficiency switch for power management in portable and battery products.

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V_{DSS}	Drain-Source Voltage	80	V
I_D	Continuous Drain Current (T_C=25℃)	80	A
	Continuous Drain Current (T_C=100℃)	68	A
I_{DM}	Pulsed Drain Current (Note 1)	320	A
V_{GS}	Gate-Source Voltage	± 25	V
E_{AS}	Single Pulsed Avalanche Energy (Note 2)	663	mJ
P_D	Maximum Power Dissipation (T_C=25℃)	200	W
	Derating Factor above 25℃	1.33	W/℃
T_J	Operating Junction Temperature Range	-55 to +175	℃
T_{STG}	Storage Temperature Range	-55 to +175	℃

Thermal Characteristics

Symbol	Parameter	Max.	Units
$R_{th\ j\text{-}c}$	Thermal Resistance, Junction to case	0.75	℃/W
$R_{th\ c\text{-}s}$	Thermal Resistance, Case to Sink	0.5	℃/W
$R_{th\ j\text{-}a}$	Thermal Resistance, Junction to Ambient	63	℃/W

Electrical Characteristics (T_C=25℃ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250uA	80	-	-	V
I_{DSS}	Drain-Source Leakage Current	V_{DS}=78V, V_{GS}=0V	-	-	1	uA
I_{GSS}	Gate Leakage Current, Forward	V_{GS}=25V, V_{DS}=0V	-	-	100	nA
	Gate Leakage Current, Reverse	V_{GS}=-25V, V_{DS}=0V	-	-	-100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS}, I_D=250uA	2.5	-	3.5	V
$R_{DS(on)}$	Drain-Source On-State Resistance	V_{GS}=10V, I_D=40A	-	6.4	7	mΩ
Qg	Total Gate Charge	V_{DD}=60V	-	110	-	nC
Qgs	Gate-Source Charge	V_{GS}=10V	-	29	-	nC
Qgd	Gate-Drain Charge	I_D=80A (Note 3)	-	52	-	nC
$t_{d(on)}$	Turn-on Delay Time	V_{DD}=37.5V,V_{GS}=10V	-	26	-	ns
t_r	Turn-on Rise Time	I_D=45A,R_G=4.7Ω	-	143	-	ns
$t_{d(off)}$	Turn-off Delay Time	T_C=25℃	-	40	-	ns
t_f	Turn-off Fall Time	(Note 3)	-	26	-	ns
Ciss	Input Capacitance -	V_{DS}=25V	-	3150	-	pF
Coss	Output Capacitance	V_{GS}=0V	-	456	-	pF
Crss	Reverse Transfer Capacitance	f = 1MHz	-	306	-	pF

Source-Drain Diode Characteristics (T_C=25℃ unless otherwise noted)

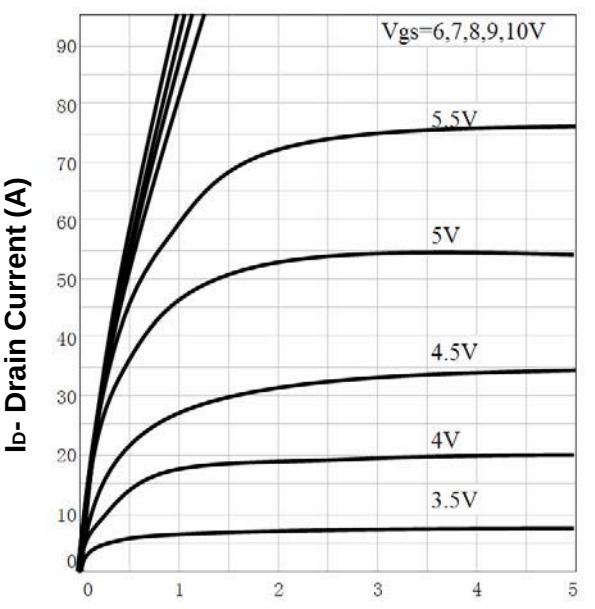
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I_S	Continuous Source Diode Forward Current		-	-	110	A
I_{SM}	Pulsed Source Diode Forward Current (Note 1)		-	-	320	A
V_{SD}	Forward On Voltage	V_{GS}=0V, I_S=45A	-	-	1.3	V
t_{rr}	Reverse Recovery Time	V_{GS}=0V, I_S=45A	-	100	150	ns
Q_{rr}	Reverse Recovery Charge	dI_F/dt = 100A/us	-	410	650	nC

Notes：

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. L=0.5mH, V_{DD}=50V, R_G=25 Ω, Starting T_J=25℃
3. Pulse Width ≤ 300 us; Duty Cycle≤2%

Typical Characteristics

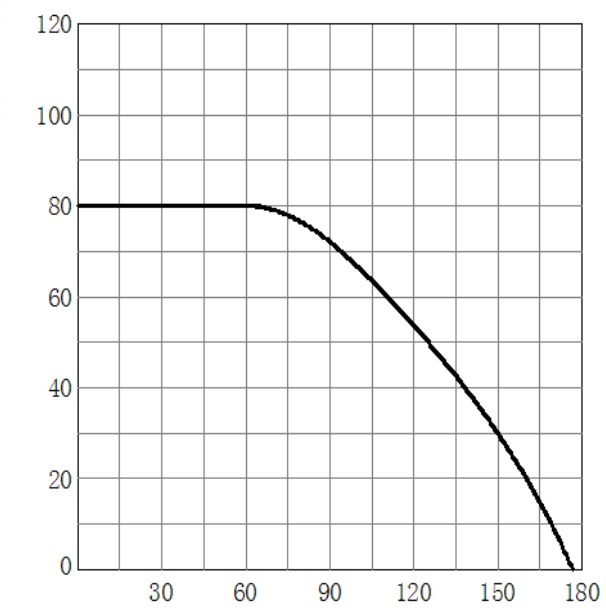
Output Characteristics



I_D- Drain Current (A)

V_{DS} - Drain-Source Voltage (V)

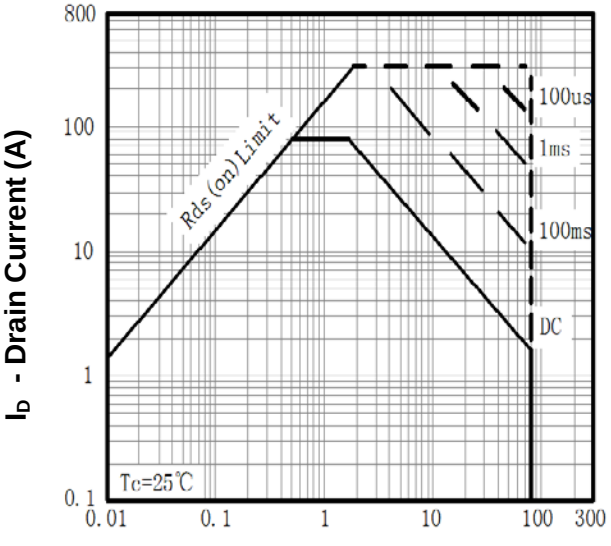
Drain Current



I_D - Drain Current (A)

T_j- Junction Temperature (°C)

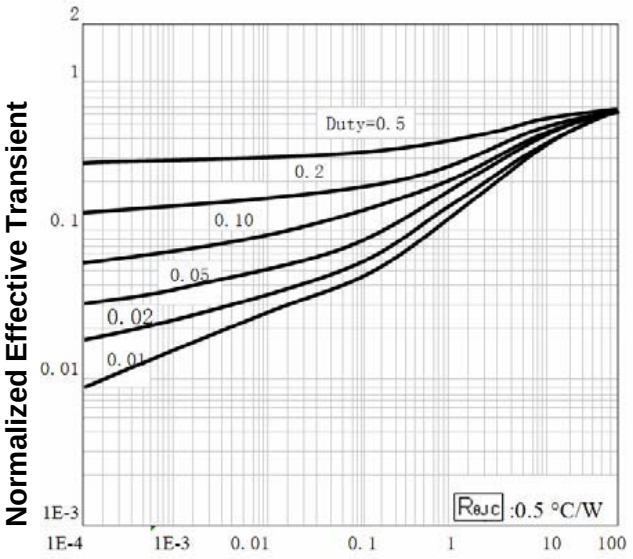
Safe Operation Area



I_D - Drain Current (A)

V_{DS}- Drain-Source Voltage (V)

Thermal Transient Impedance

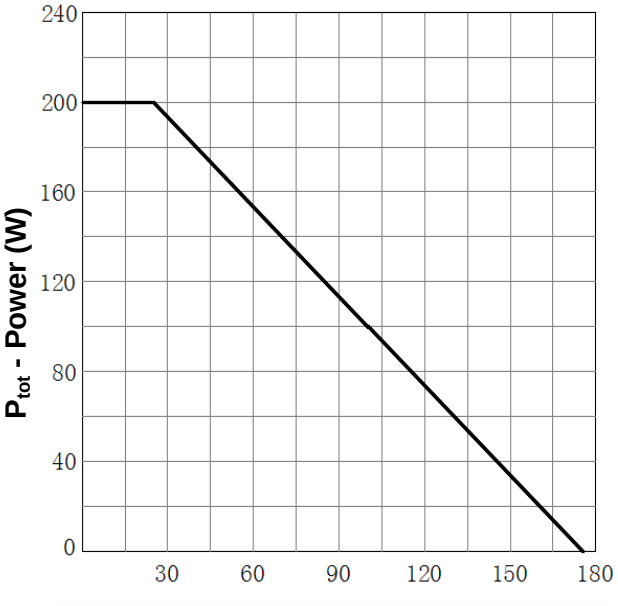


Normalized Effective Transient

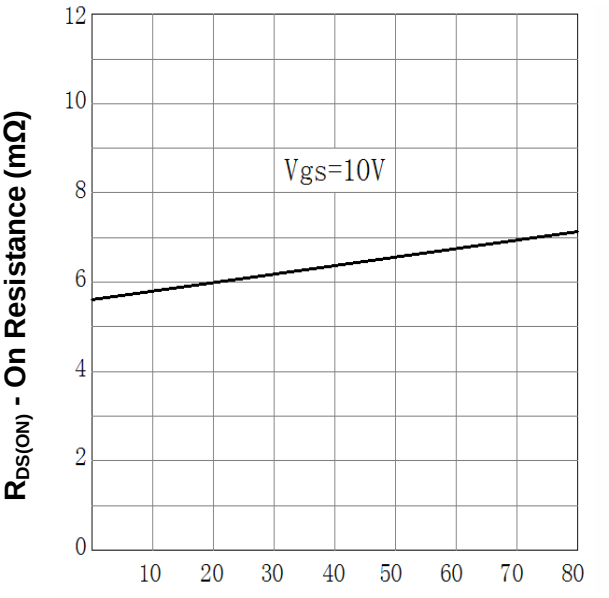
Square Wave Pulse Duration (sec)

Typical Characteristics

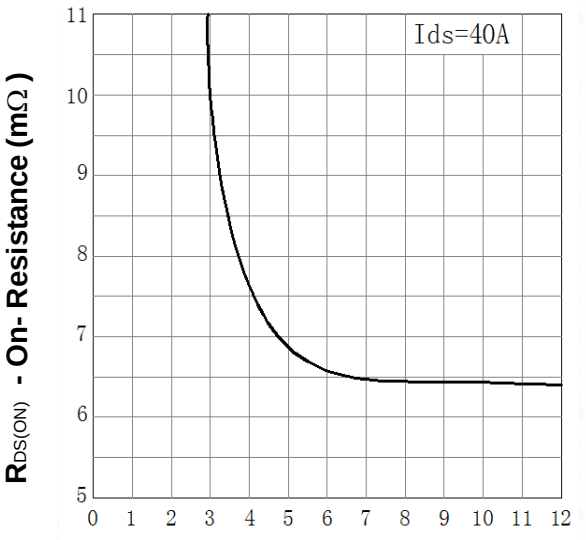
Power Dissipation



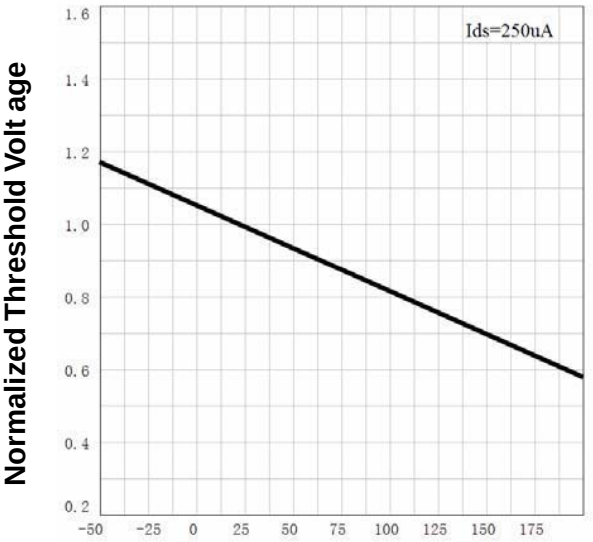
Drain-Source On Resistance



Drain-Source On Resistance

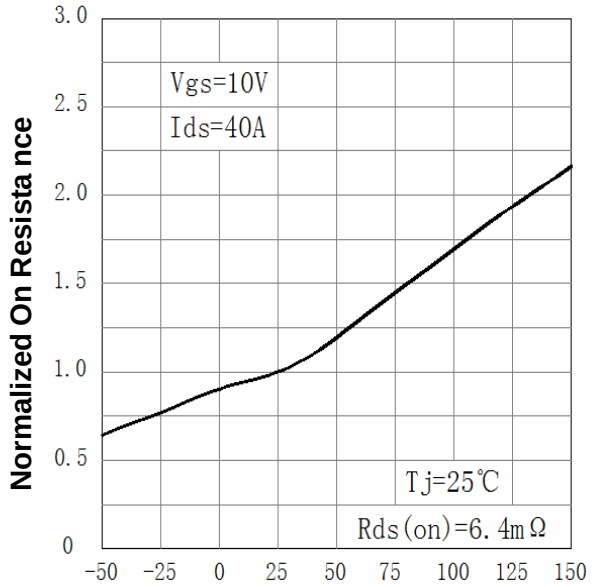


Gate Threshold Voltage



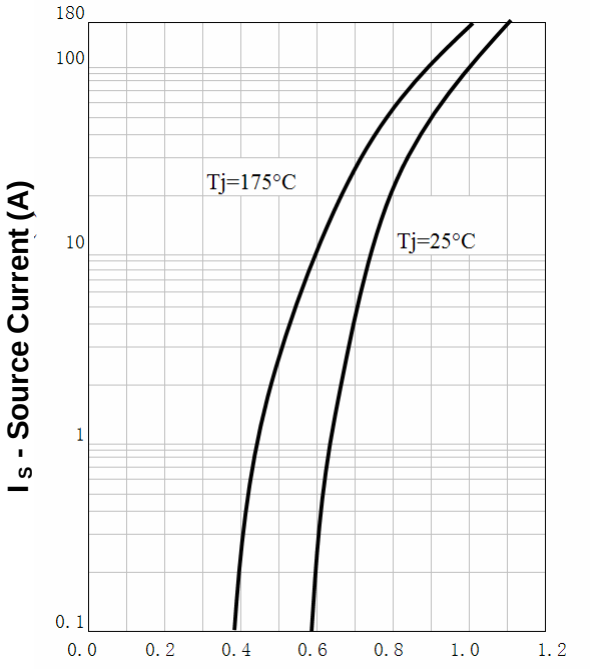
Typical Characteristics

Drain-Source On Resistance



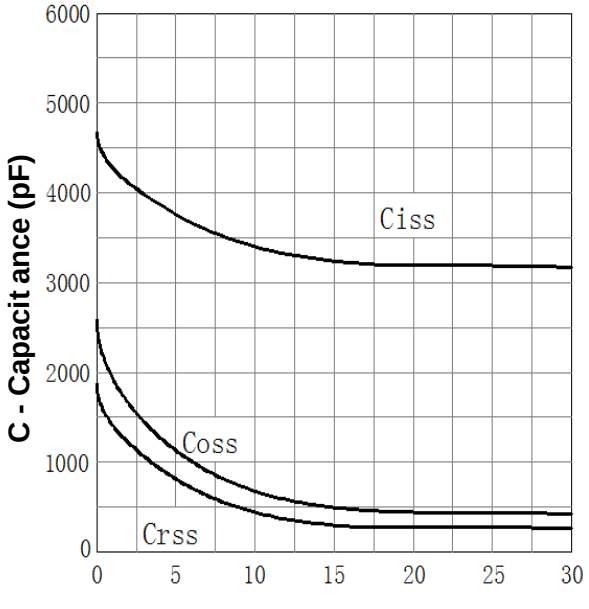
T_j- Junction Temperature (°C)

Source-Drain Diode Forward



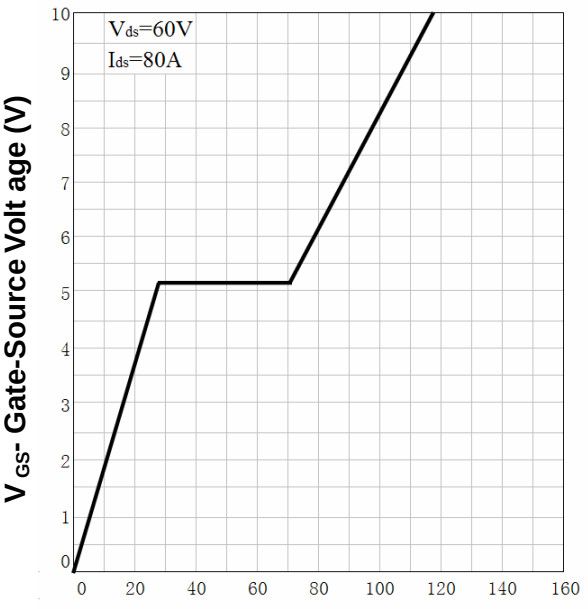
V_{SD}- Source-Drain Voltage (V)

Capacitance



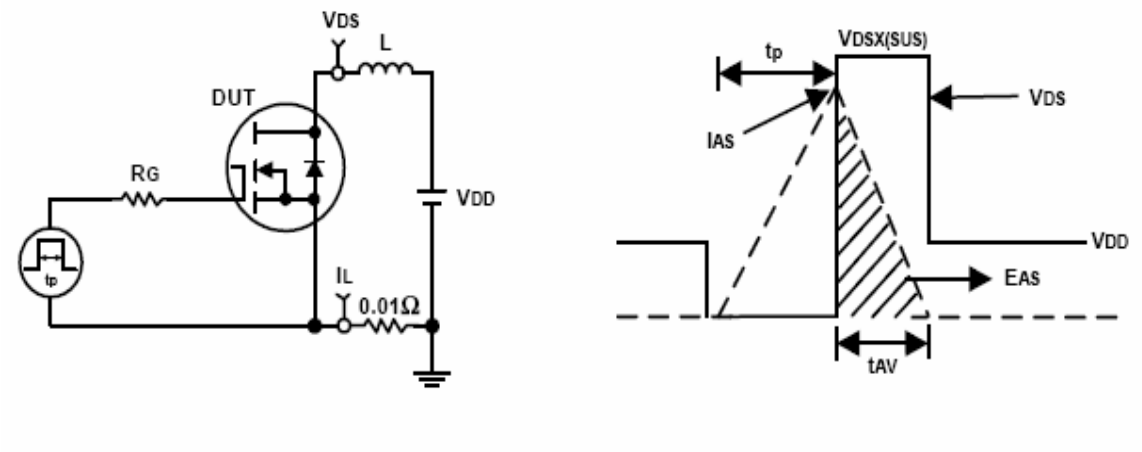
V_{DS}- Drain-Source Voltage (V)

Gate Charge

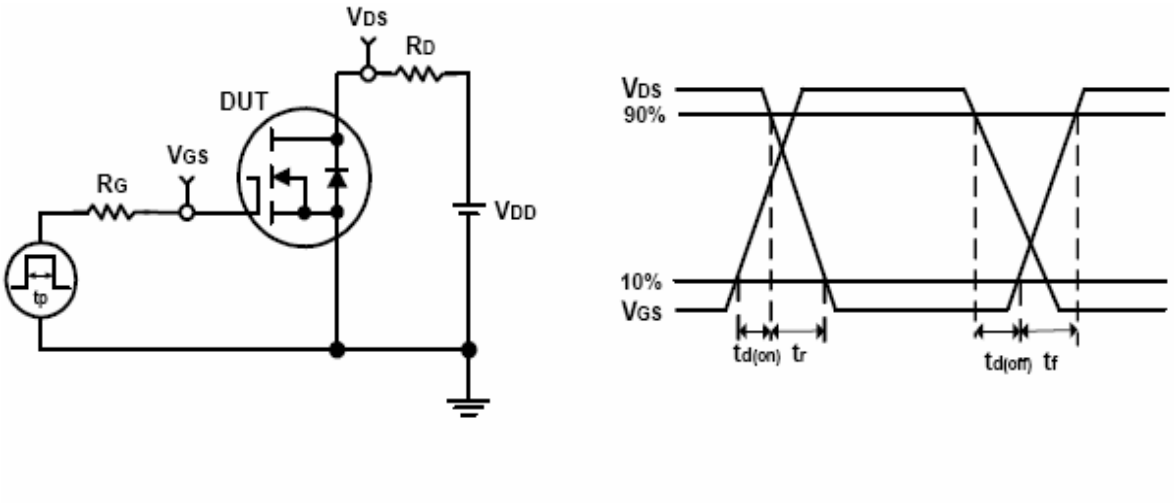


Q_G - Gate Charge (nC)

Avalanche Test Circuit and Waveforms



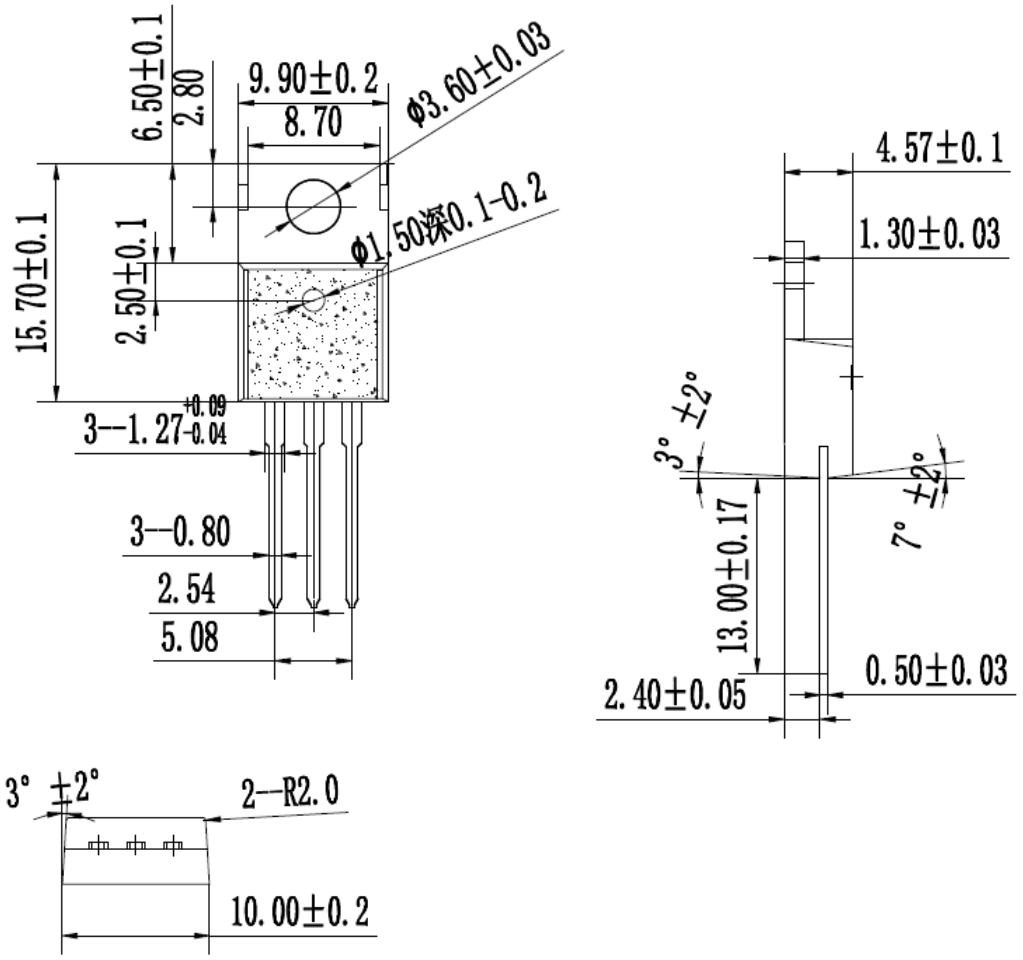
Switching Time Test Circuit and Waveforms



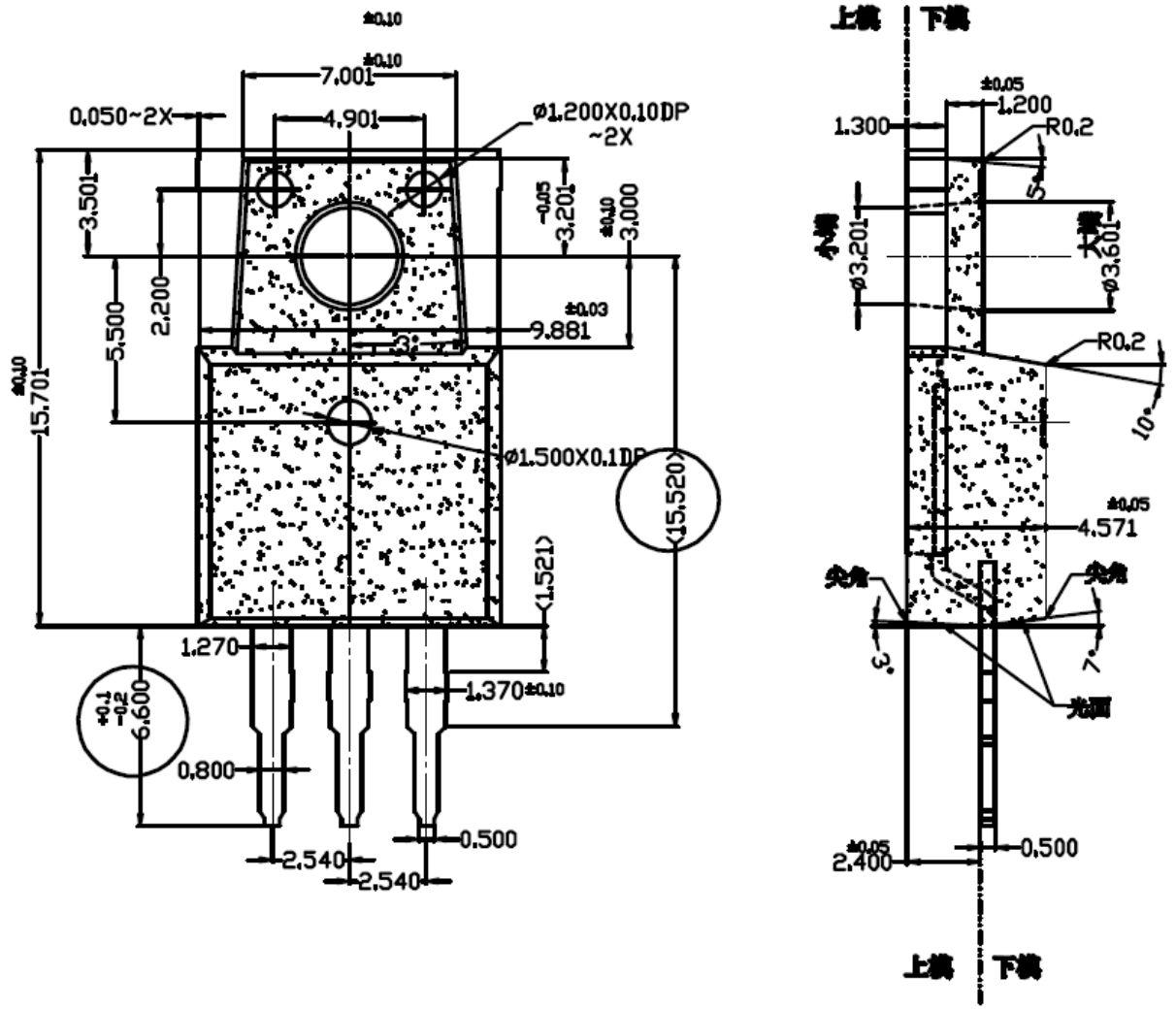
Package Outline

Dimensions are shown in millimeters

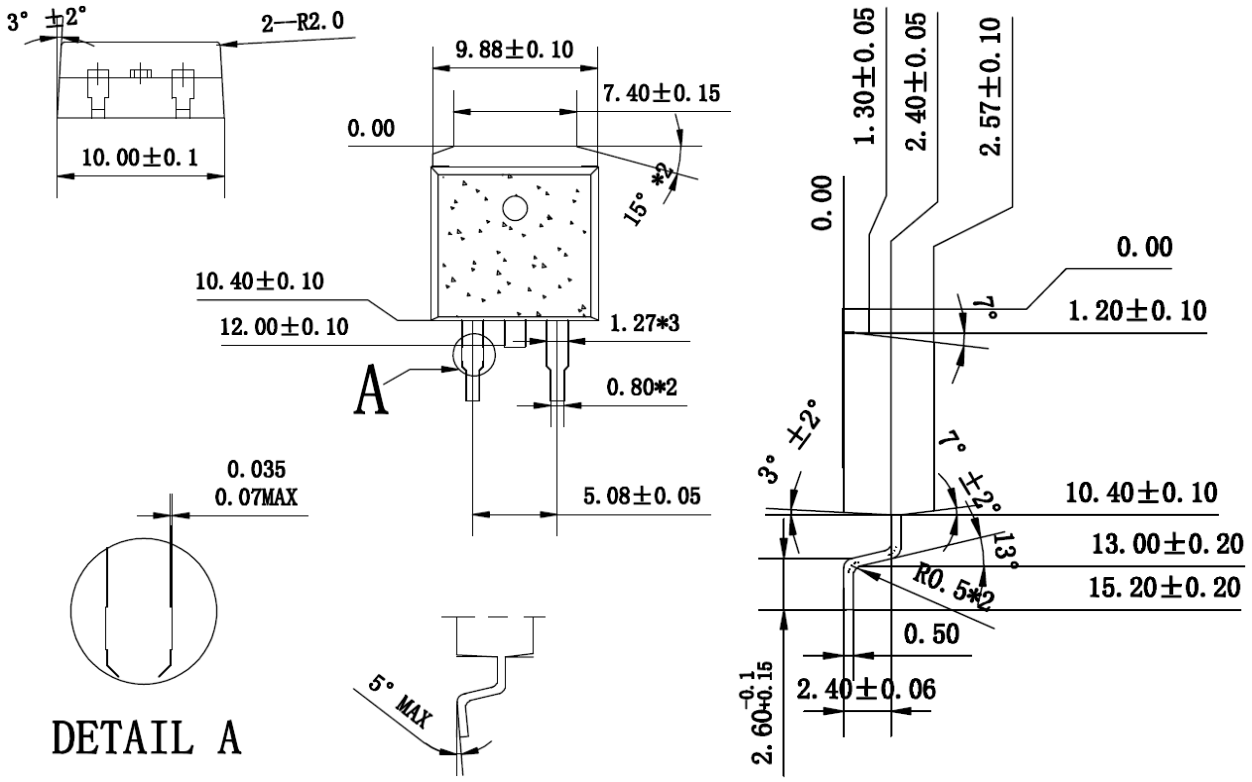
R：TO220



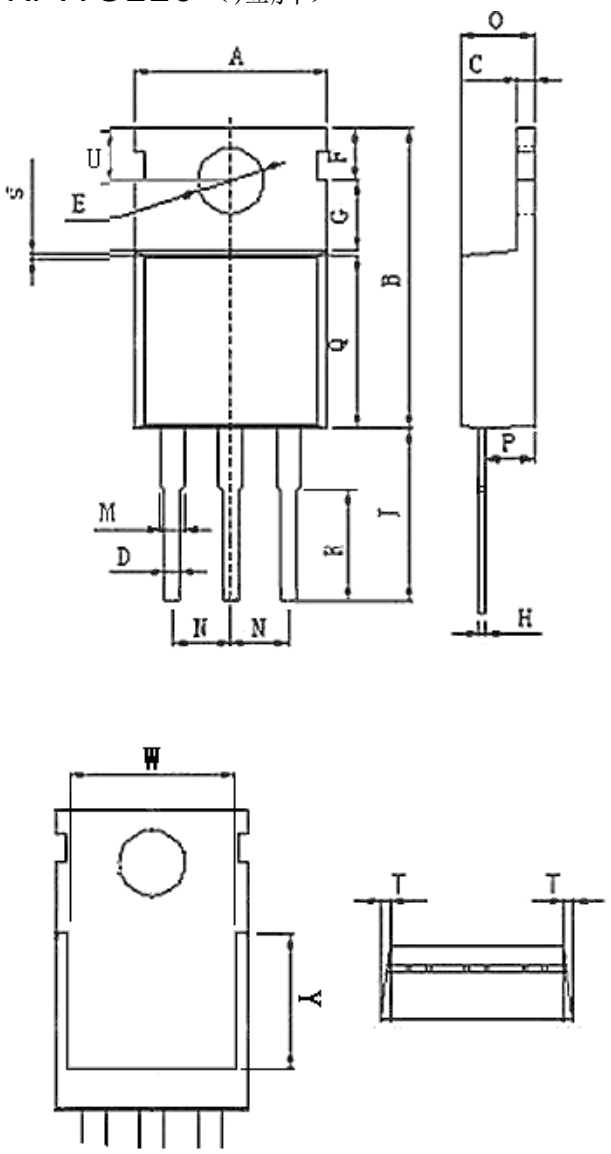
RN:TO220-SHORT



S：TO263（D^2PAK）



RP:TO220（短脚）



DIM	MILLIMETERS
A	10.1±0.2
B	15.6±0.2
C	1.2±0.2
D	0.8±0.2
E	3.7±0.2
F	3.0±0.2
G	3.6±0.2
H	0.5±0.2
J	6.5±0.1
K	3.5±0.1
M	1.3±0.2
N	2.6±0.2
O	4.5±0.2
P	2.0±0.2
Q	9.0±0.2
S	0.25±0.1
T	0.25±0.1
U	2.8±0.07
W	8.0±0.2
Y	6.4±0.2

（单位：mm）